

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property  
Organization  
International Bureau



(43) International Publication Date  
28 July 2005 (28.07.2005)

PCT

(10) International Publication Number  
**WO 2005/069366 A1**

(51) International Patent Classification<sup>7</sup>: **H01L 21/68,**  
G02F 1/1333

(21) International Application Number:  
PCT/JP2005/000712

(22) International Filing Date: 13 January 2005 (13.01.2005)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:  
2004-009021 16 January 2004 (16.01.2004) JP

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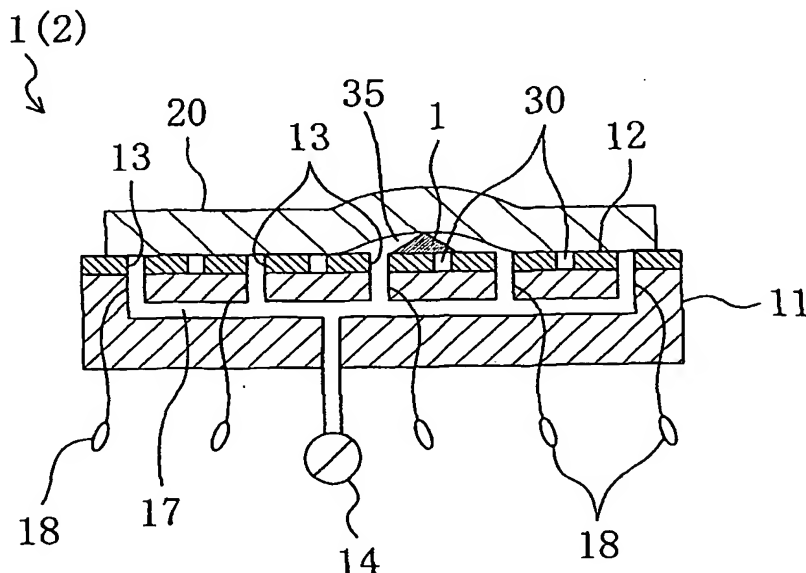
(81) Designated States (unless otherwise indicated, for every  
kind of national protection available): AE, AG, AL, AM,  
AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN,  
CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI,  
GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE,  
KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD,  
MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG,  
PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM,  
TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM,  
ZW.

(84) Designated States (unless otherwise indicated, for every  
kind of regional protection available): ARIPO (BW, GH,  
GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM,  
ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM),  
European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI,  
FR, GB, GR, HU, IE, IS, IT, LT, LU, MC, NL, PL, PT, RO,  
SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN,  
GQ, GW, ML, MR, NE, SN, TD, TG).

Published:  
— with international search report

For two-letter codes and other abbreviations, refer to the "Guid-  
ance Notes on Codes and Abbreviations" appearing at the begin-  
ning of each regular issue of the PCT Gazette.

(54) Title: SUBSTRATE ADSORPTION DEVICE AND SUBSTRATE BONDING DEVICE



(57) Abstract: A substrate  
adsorption device 1 includes: a  
stage 11 having an adsorption  
face 12 for holding a substrate  
20; a plurality of adsorption  
ports 13 formed in a region of  
the adsorption face 12 of the  
stage 11; and a vacuum pump 14  
connected to each adsorption port  
through an air discharge path 17.  
A pressure sensor 18 for detecting  
the pressure in the air discharge  
path 17 is provided, and a plurality  
of leak trenches 30 open to both  
the adsorption face 12 of the  
stage 11 and a side face of the  
stage 11 are formed in a region  
of the stage 11 except the region  
where the adsorption ports 13  
are formed. With such a low-cost  
and simple structure, a foreign  
matter 15, which is a factor of  
inviting damage to the substrate  
20, is detected, to prevent damage  
to the substrate 20.

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